



Serial No. 09/893,455

SKI.007D

Amendment dated February 5, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Hiroyuki Nishi et al.

Group Art Unit: 1732

Serial No.: 09/893,455

Examiner: A. Ortiz

Filed: June 29, 2001

Confirm. No.: 7179

For: **TRANSFER MOLDING METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICES**

AMENDMENT UNDER 37 C.F.R. 1.116

U.S. Patent and Trademark Office
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Arlington, VA 22202

Date: February 5, 2004

Sir:

In response to the Final Office Action dated November 6, 2003, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.